Special Issue

CMOS Chips for Sensing and Communication

Message from the Guest Editors

This Special Issue encourages researchers to present theories, techniques, circuits, and systems of CMOS chips for radar/image sensing and wireless communication regarding emerging issues and challenges. The scope of this Special Issue focuses on. but is not limited to: **Imaging sensors**: The development of image sensing with better performance and diverse functions, including high speed, high dynamic range, 3D imaging, low-light imaging and dynamic vision sensors, etc. RF circuits: Building blocks at RF, mm-Wave and THz frequencies for receivers, transmitters, frequency synthesizers, transceivers, SoCs, and SiPs. Wireless radar/communication transceivers: Circuit-level and system-architecture solutions for low-power, energyefficient and high-performance wireless links, emerging broadband and phased-array systems, vehicle-toeverything (V2X), millimeter-wave and THz systems (radar, imaging, or communication).

Guest Editors

Prof. Dr. Fanyi Meng

Dr. Guangyin Feng

Dr. Kaiming Nie

Deadline for manuscript submissions

closed (31 March 2023)



Electronics

an Open Access Journal by MDPI

Impact Factor 2.6 CiteScore 6.1



mdpi.com/si/129594

Electronics
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
electronics@mdpi.com

mdpi.com/journal/electronics





Electronics

an Open Access Journal by MDPI

Impact Factor 2.6 CiteScore 6.1



About the Journal

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and Telecommunications, Politecnico di Torino, 10129 Torino, Italy

Author Benefits

High Visibility:

indexed within Scopus, SCIE (Web of Science), CAPlus / SciFinder, Inspec, Ei Compendex and other databases.

Journal Rank:

JCR - Q2 (Engineering, Electrical and Electronic) / CiteScore - Q1 (Electrical and Electronic Engineering)

Rapid Publication:

manuscripts are peer-reviewed and a first decision is provided to authors approximately 16.8 days after submission; acceptance to publication is undertaken in 2.4 days (median values for papers published in this journal in the first half of 2025).

